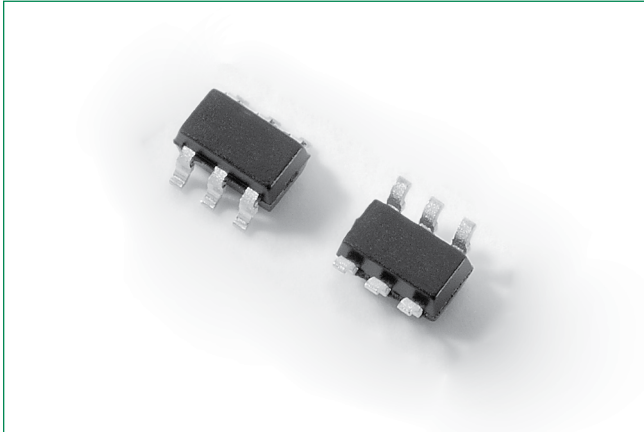


# DSL P Series - SOT23-6

## Broadband Optimized™ Protection



### Description

This new DSL P Series provides overvoltage protection for applications such as HD-SDI, HD-CVBS, ADSL, ADSL2, ADSL2+, VDSL2, Vplus (35b), and G.fast with minimal effect on data signals. This silicon design innovation results in a capacitive loading characteristic that is compatible with these high bandwidth applications.

These components adopt the patent granted EpiSCR silicon crowbar technology and industry popular cost competitive SOT23-6 package with flow-through lead frame design.

There are various  $V_{DRM}$  options available in this series. This technology provides a better surge capability than traditional clamping silicon technology. This reduces the possibility of field failures caused by A.C. power fault and multiple transient surges or lightning without compromising the signal integrity particularly at high data rate.

### Additional Information



Resources



Accessories

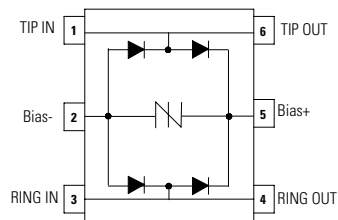


Samples

### Agency Approvals

Agency	Agency File Number
	E133083

### Pinout Designation & Schematic Symbol



### Features & Benefits

- Compatible with ADSL, ADSL2+, VDSL2, VDSL2+ (35.328MHz, VDSL2 35b profile) and G.fast (both 106MHz & 212MHz)
- Balanced voltage protection
- Superior surge capability of 30 A min, 35 A typ @ 8/20 $\mu$ s, 15 A typ @ 5/310  $\mu$ s
- Fast response time
- Wide variety VDRM options for precise protection level needs
- Ultra low capacitance characteristic provides low insertion loss and less distortion particularly in higher data rate signals
- RoHS Compliant
- Flow-through pin assignment and layout ideal for high data rate
- Pb-free E3 means 2nd level interconnect is Pb-free and the terminal finish material is tin(Sn) (IPC/JEDEC J-STD-609A.01)

### Applicable Global Standards

- IEC 61000-4-5 2nd edition, 30 A min (tp = 8/20)

### Electrical Characteristics between pin 1 and pin 3, $T_a = 25^\circ\text{C}$

Part Number	Marking	$V_{DRM} @ I_{DRM}=100\text{nA}$	$I_R @ V_{DRM}$	$V_S @ 100\text{V}/\mu\text{s}$	$I_H$	$I_S$	Capacitance @f=1MHz,2V bias	
		V min	pA typ	V max	mA typ	mA min	pF typ	pF max
DSL P0080T023G6RP	D08	8	300	18	40	10	1.3	2.5
DSL P0120T023G6RP	D12	12	300	22	40	10	1.3	2.5
DSL P0180T023G6RP	D18	18	300	28	40	10	1.3	2.5
DSL P0240T023G6RP	D24	24	300	34	40	10	1.3	2.5
DSL P0360T023G6RP	D36	36	300	48	40	10	1.3	2.5

# DSLIP Series - SOT23-6

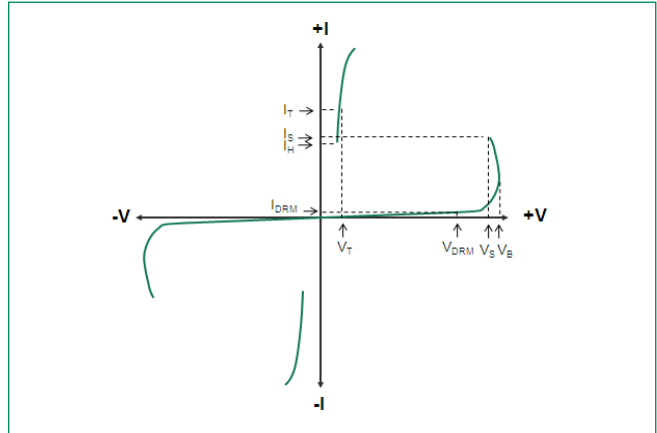
## Broadband Optimized™ Protection

### Surge Ratings

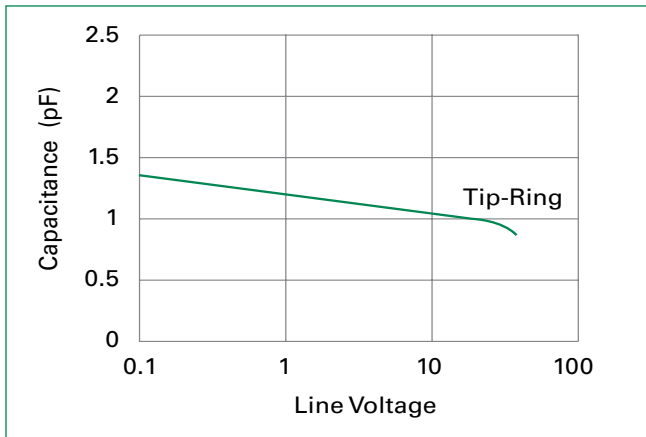
Series	$I_{PP}$		
	8/20 <sup>1</sup> 1.2/50 <sup>2</sup>		5/310 <sup>1</sup> 10/700 <sup>2</sup>
	A min	A typ	A typ
G	30	35	15

**Notes:**  
 1 Current waveform in  $\mu s$  - Peak pulse current rating ( $I_{PP}$ ) is repetitive and guaranteed for the life of the product that remains in thermal equilibrium.  
 2 Voltage waveform in  $\mu s$  - The component must be in thermal equilibrium at 25°C.

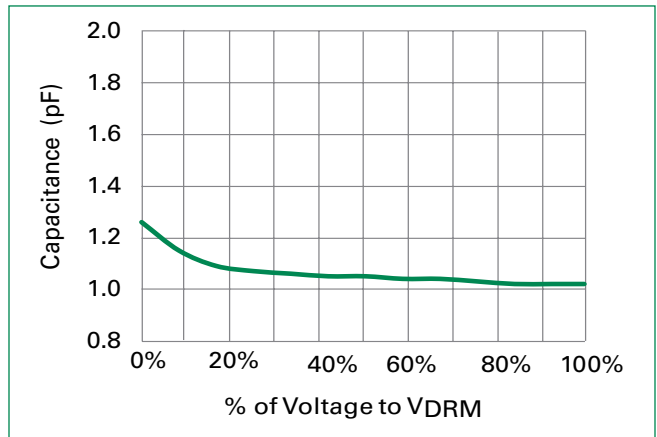
### V-I: Characteristics



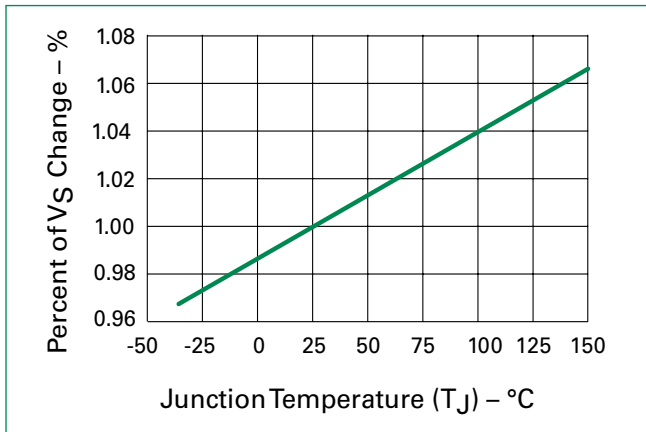
### Capacitance vs. Voltage



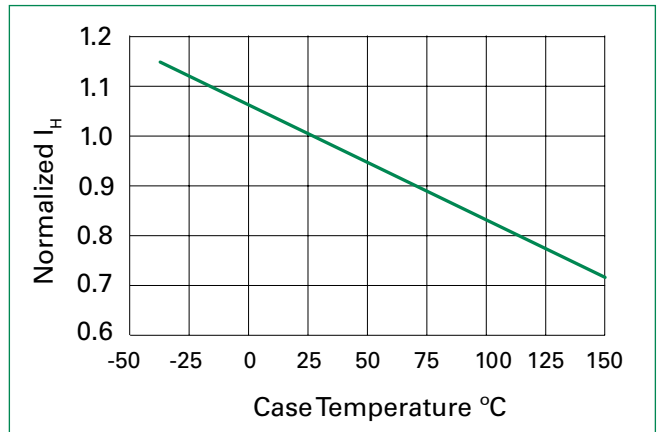
### Typical capacitance against line voltage (without external bias)



### Normalized VS Change vs. Junction Temperature



### Normalized Holding Current vs. Case Temperature



# DSL Series - SOT23-6

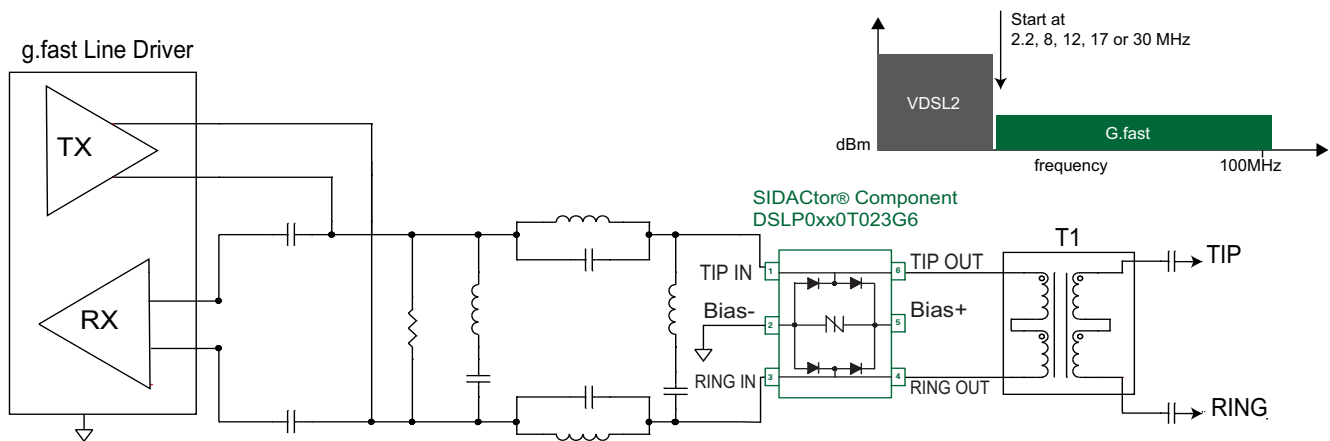
## Broadband Optimized™ Protection

### Thermal Information

Parameter	Value	Unit
Storage Temperature Range	-55 to 150	°C
Maximum Junction Temperature	150	°C
Maximum Lead Temperature (Soldering 10s)	260	°C

### Application example - G.fast Protection

G.fast has a targeted data rate of 1Gbps over 100 m of single twisted pair (24 AWG/0.5 mm) cable using DSL-like technology. This TDD (Time Division Duplex) signaling is a major difference from the existing FDD (Frequency Division Duplex) DSL signaling. G.fast bandwidth will extend up to 106 MHz (with the potential of going as high as 212 MHz) with the start frequency ranging from 2.2 MHz up to 30 MHz in an effort to avoid interference with existing xDSL services. G.fast may also employ “notching” where it suppresses carriers at specific individual frequencies to avoid clashing with local RF services.



### About G.fast

The G.fast amplitude is very low as compared to existing xDSL services and thus the varying voltage across the SIDACtor® component is very low. This results in imperceptible capacitance variance of the over voltage protection (OVP) component; therefore a bias voltage on pins 2 & 5 is not required in most applications, but pin 2 can be connected to the G.fast driver ground reference to provide longitudinal protection along with the differential protection mode. Rate and reach testing has shown an acceptable loss of less than 0.2dB with the DSLP0xx0T023G6RP component included at the tertiary position. Additionally, the flow-through layout of this component reduces the impedance mismatching “stub-effect” caused by non-“flow-through” PCB trace connections and provides for an easier PCB design. The small SOT23-6 footprint conserves valuable PCB real-estate space requirements.

Since this interface is capacitively coupled, no fusing is required for power fault protection, however; selection of appropriately voltage rated capacitors must be considered regarding lightning exposure risks. The coupling transformer should have an isolation rating of at least 1.5kV 50/60Hz and consideration of its lightning response characteristics must also be considered. The IPP 8/20 surge rating of this DSLP0xx0T023G6RP series is 30A minimally with a typical IPP rating of 35A based on this waveshape. This should be sufficient for even the most severe exposure G.fast applications (including GR-1089 Issue 6 interbuilding requirements and ITU K20/2¼5 Enhanced external line recommendations). The “Bias -” lead can be connected to the line driver ground with the “Bias +” lead left open so this solution provides both differential and common mode protection. Both “Bias -” and “Bias +” leads can be left floating for differential only protection and finally for capacitance variance sensitive applications, the “Bias -” and “Bias +” leads may have the appropriate polarity voltage (< VDRM) applied to further minimize any negative capacitance effects.

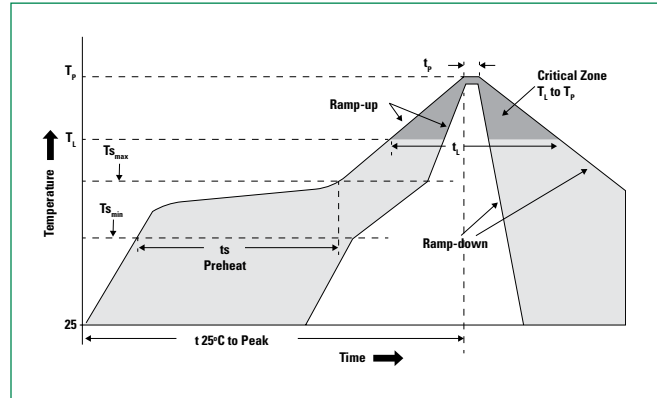
The higher VDRM components in this DSLP series can be considered for ADSL, ADSL2, VDSL2, and VDSL2+ applications where the signal levels are much higher than the G.fast signals. The low off-state capacitance (>2pF max) and the flow-through compatible SOT23-6 footprint properties of this series is also beneficial for these other xDSL applications.

# DSL Series - SOT23-6

## Broadband Optimized™ Protection

### Soldering Parameters

<b>Reflow Condition</b>		Pb-Free assembly
<b>Pre Heat</b>	- Temperature Min ( $T_{s(min)}$ )	150°C
	- Temperature Max ( $T_{s(max)}$ )	200°C
	- Time (Min to Max) ( $t_s$ )	60-180 secs.
<b>Average ramp up rate (Liquidus Temp (<math>T_L</math>) to peak)</b>		3°C/sec. Max.
<b><math>T_{s(max)}</math> to <math>T_L</math> - Ramp-up Rate</b>		3°C/sec. Max.
<b>Reflow</b>	- Temperature ( $T_L$ ) (Liquidus)	+217°C
	- Temperature ( $t_l$ )	60-150 secs.
<b>Peak Temp (<math>T_p</math>)</b>		250(+0/-5)°C
<b>Time within 5°C of actual Peak Temp (<math>t_p</math>)</b>		20-40 secs.
<b>Ramp-down Rate</b>		6°C/sec. Max.
<b>Time 25°C to Peak Temp (<math>T_p</math>)</b>		8 min. Max.
<b>Do not exceed</b>		260°C



### Physical Specifications

<b>Lead Plating</b>	Matte Tin
<b>Lead Material</b>	Copper Alloy
<b>Lead Coplanarity</b>	0.0004 inches (0.102mm)
<b>Substitute Material</b>	Silicon
<b>Body Material</b>	Molded Compound
<b>Flammability</b>	UL Recognized compound meeting flammability rating V-0

**Notes:**

- All dimensions are in millimeters.
- Dimensions include solder plating.
- Dimensions are exclusive of mold flash & metal burr.
- All specifications comply to JEDEC MO-178
- Bl is facing up for mold and facing down for trim/form, i.e. reverse trim/form.
- Package surface matte tin

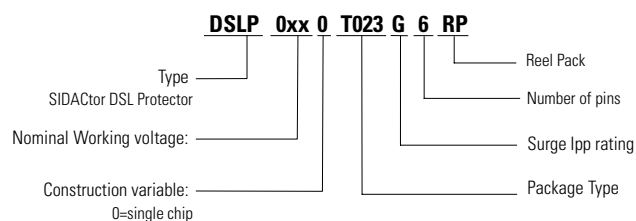
### High Reliability Test Specification

<b>Pre-condition (HTRB/ TC/ PCT/ H3TRB)</b>	(1) Bake 24hrs @150°C (2) 168hrs @85% RH and 85°C (3) $I_R$ reflow, 3 reflows, peak temperature of 260°C
<b>HTRB</b>	JESD 22-108 $V_{CC}$ bias= 80% $V_{DRM}$ & $T_A=150°C$ , 1008hrs
<b>Temperature Cycling</b>	MIL-STD-883, Method 1010.8 Condition C -65°C to 150°C, 1000 cycles
<b>Pressure Cooker</b>	JEDEC 22-A102 100%RH @121°C @15psi, 96hrs
<b>Bias Humidity (H3TRB)</b>	JESD 22-A101 $V_{CC}$ bias (pin1 to pin3)= $V_{DRM}$ , 85%RH, 85°C, 1008 hours
<b>RSH</b>	JESD 22-A111 260°C, 10 secs.

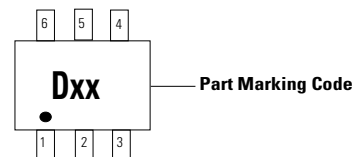
### Packing Options

Package Type	Description	Quantity
SOT23-6	Tape and Reel	3000

### Part Numbering



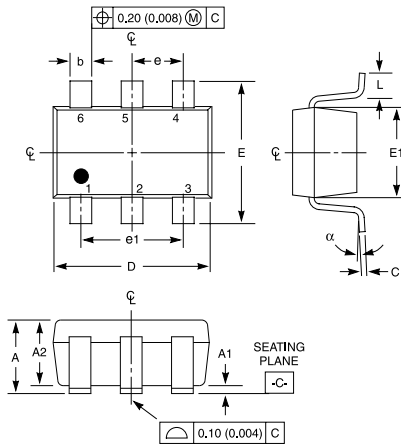
### Part Marking



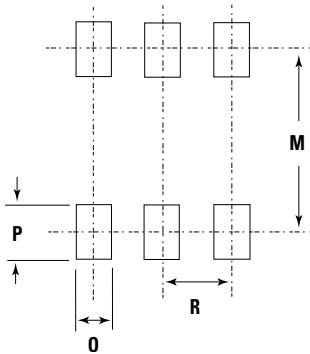
# DSL P Series - SOT23-6

## Broadband Optimized™ Protection

### Dimensions - SOT23-6



Recommended Solder Pad Layout

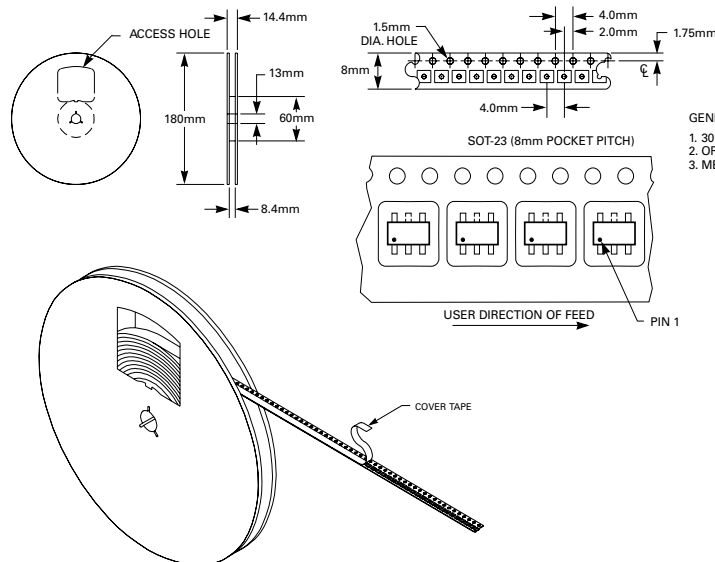


Dimensions	Inches		Millimeters	
	Min	Max	Min	Max
A	0.041	0.057	1.050	1.450
A1	0.000	0.006	0.000	0.150
A2	0.035	0.051	0.900	1.300
b	0.012	0.020	0.300	0.500
C	0.003	0.008	0.080	0.220
D	0.110	0.118	2.800	3.000
E	0.102	0.118	2.600	3.000
E1	0.057	0.069	1.450	1.750
e	0.037(BSC)		0.950(BSC)	
e1	0.075(BSC)		1.900(BSC)	
L (note 4 & 5)	0.012	0.023	0.300	0.600
N (note 6)	6		6	
	0°C	8°C	0°C	8°C
Ø	-	0.102	-	2.590
O	-	0.027	-	0.690
P	-	0.039	-	0.990
R	-	0.038	-	0.950

**Notes:**

1. Dimensioning and tolerances per ANSI 14.5M-1982.
2. Package conforms to JEDEC MO-178
3. Dimensions D and E1 are exclusive of mold flash, protrusions, or gate burrs.
4. Foot length L measured at reference to seating plane.
5. "L" is the length of flat foot surface for soldering to substrate.
6. "N" is the number of terminal positions.
7. Controlling dimension: MILLIMETER. Converted inch dimensions are not necessarily exact.

### Embossed Carrier Tape & Reel Specification - SOT23-6



- GENERAL INFORMATION**
1. 3000 PIECES PER REEL.
  2. ORDER IN MULTIPLES OF FULL REELS ONLY.
  3. MEETS EIA-481 REVISION 'A' SPECIFICATIONS.

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